

## The IP Subsystem Market: An Evolving Landscape

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# Table of Contents

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Table of Contents .....	i
List of Tables .....	ii
List of Figures .....	iv
I. Executive Overview .....	1
II. Semiconductor Market Perspective - 2016 .....	5
III. Evolution and Integration in the Semiconductor Industry .....	7
Evolution of the SIP Market Driven by the Discrete Semiconductor Market .....	10
Evolution of the IP Megablock .....	12
Evolution of the IP Subsystem Market .....	12
IV. IP Subsystems: Why the change in SoC design direction, and why now? .....	14
Growth in Device Complexity .....	16
Rising IP Integration Costs .....	17
V. IP Subsystems – The Beginning .....	23
VI. Changes in the SoC Design Methodology .....	26
VII. IP Subsystem Definitions .....	30
IP Megablock .....	30
IP Subsystem .....	30
SoC Virtualization .....	31
Evolved Audio IP Block in Today's SoC .....	31
VIII. New IP Subsystems Enter the Market .....	34
Evolution in the IP Subsystems Market .....	48
Rising Device Complexity Requires New Tools and Approaches to Design Flows .....	56
Potential Direction for the Near Future .....	59
Features of IP Subsystems .....	61
Advantages of IP Subsystems .....	62
Disadvantages of IP Subsystems .....	63
Rethinking the SoC Design Methodology .....	63
IX. Categories of IP Subsystems in the Market Today .....	68
New Class of IP Subsystems .....	70
IP Subsystem Vendors in the Market Today .....	72
X. Different Business Models for 3 <sup>rd</sup> Party SIP Vendors .....	73
The Broad Product Portfolio IP Vendor as IP Subsystem Supplier .....	74
The Limited Product Portfolio IP Vendor as IP Subsystem Supplier .....	74
The IP Subsystem Facilitator .....	74
The Collaborative IP Subsystem Vendor .....	75
The Partial IP Subsystem Vendor .....	75
XI. IP Subsystem Market Forecast .....	78
Total Worldwide IP Subsystem Market Forecast .....	78
Total Worldwide IP Subsystem Market Revenue Forecast by IP Category .....	80
IP Subsystem Market Forecast by End Application Category .....	94
Worldwide IP Subsystem Market Revenue Forecast by Region .....	109
IP Subsystem Forecast for Design Starts by Device Type .....	117
IP Subsystem Forecast for Design Starts by Device Type and Process Geometry .....	127
XII. Future Directions in the IP Subsystem Market .....	136
XIII. Summary .....	138
XIV. Actionable Items .....	139

## List of Tables

---

Table 1: General List of System Functions and SIP Block Level Solutions.....	14
Table 2: Crossover Point for IP Integration Cost: Silicon vs. Software .....	19
Table 3: List of Imaging Video Accelerator Features for TI OMAP Processors.....	24
Table 4: List of Device Manufacturers Creating IP Subsystems .....	25
Table 5: Requirements for Commercialization of IP Subsystems I.....	64
Table 6: Requirements for Commercialization of IP Subsystems II.....	65
Table 7: SWOT Analysis from the IP Subsystem Vendors Point of View.....	76
Table 8: SWOT Analysis from the SoC Designers Point of View .....	77
Table 9: Worldwide IP Subsystem Revenue Forecast by IP Category .....	80
Table 10: Worldwide Memory IP Subsystem Revenue Forecast by Application.....	81
Table 11: Total Worldwide Video IP Subsystem Revenue Forecast by Application .....	82
Table 12: Total Worldwide Communications IP Subsystem Revenue Forecast by Application.....	83
Table 13: Total Worldwide Storage IP Subsystem Revenue Forecast by Application.....	84
Table 14: Total Worldwide Multi Media IP Subsystem Revenue Forecast by Application .....	85
Table 15: Total Worldwide Audio IP Subsystem Revenue Forecast by Application .....	86
Table 16: Total Worldwide System Resource Mgmt. IP Subsystem Revenue Forecast by Application.....	87
Table 17: Total Worldwide Security IP Subsystem Revenue Forecast by Application.....	88
Table 18: Total Worldwide IoT Platform IP Subsystem Revenue Forecast by Application .....	89
Table 19: Total Worldwide Computing IP Subsystem Revenue Forecast by Application .....	90
Table 20: Total Worldwide Embedded Debug IP Subsystem Revenue Forecast by Application .....	91
Table 21: Total Worldwide Embedded Vision IP Subsystem Revenue Forecast by Application .....	92
Table 22: Total Worldwide Power Management IP Subsystem Revenue Forecast by Application .....	93
Table 23: Worldwide IP Subsystem Market Forecast by Application.....	95
Table 24: Worldwide IP Subsystem Unit Shipments Forecast by Application .....	96
Table 25: Total Worldwide IP Subsystem Revenue Forecast by Consumer Applications .....	97
Table 26: Worldwide IP Subsystem Unit Shipment Forecast for Consumer Applications by Device Type	98
Table 27: Worldwide IP Subsystem Market Forecast for Computer Applications.....	99
Table 28: Worldwide IP Subsystem Market Forecast for Computer Applications by Device Type .....	100
Table 29: Worldwide IP Subsystem Revenue Forecast for Communication Applications.....	101
Table 30: Worldwide IP Subsystem Unit Shipment Forecast for Communication Applications by Device Type....	102
Table 31: Worldwide IP Subsystem Revenue Forecast for Automotive Applications .....	103
Table 32: Worldwide IP Subsystem Unit Shipment Forecast for Automotive Applications by Device Type .....	104
Table 33: Worldwide IP Subsystem Revenue Forecast for Industrial Applications .....	105
Table 34: Worldwide IP Subsystem Unit shipment Forecast for Industrial Applications by Device Type	106
Table 35: Worldwide IP Subsystem Revenue Forecast for Military Applications .....	107
Table 36: Worldwide IP Subsystem Unit Shipment Forecast for Military Applications by Device Type .	108
Table 37: Worldwide IP Subsystem Revenue Forecast by Region.....	110
Table 38: Americas IP Subsystem Revenue Forecast by Product Type .....	112
Table 39: Europe IP Subsystem Revenue Forecast by Product Type .....	113
Table 40: Japan IP Subsystem Revenue Forecast by Product Type .....	114
Table 41: Asia Pacific IP Subsystem Revenue Forecast by Product Type .....	115
Table 42: China IP Subsystem Revenue Forecast by Product Type .....	116
Table 43: Worldwide IP Subsystem Design Start Forecast by Product Type.....	119
Table 44: Worldwide Design Start Forecast for Advanced Performance Multicore SoC by Application..	120
Table 45: Worldwide Design Start Forecast for Value Multicore SoC by Application.....	121
Table 46: Worldwide Design Start Forecast for Basic SoC by Application.....	122
Table 47: Worldwide Design Start Forecast for Programmable SoC by Application .....	123
Table 48: Worldwide Design Start Forecast for Platform SoC by Application .....	124
Table 49: Worldwide Design Start Forecast for Slice SoC by Application .....	125
Table 50: Worldwide Design Start Forecast for SoPC SoC by Application.....	126
Table 51: Total Worldwide Design Start Forecast for SoC by Process Geometry .....	128

Table 52: Worldwide Design Start Forecast for Advanced Performance Multicore SoC by Process Geometry .....	129
Table 53: Worldwide Design Start Forecast for Value Multicore SoC by Process Geometry .....	130
Table 54: Worldwide Design Start Forecast for Basic SoC by Process Geometry .....	131
Table 55: Worldwide Design Start Forecast for Programmable SoC by Process Geometry.....	132
Table 56: Worldwide Design Start Forecast for Platform SoC by Process Geometry .....	133
Table 57: Worldwide Design Start Forecast for Slice SoC by Process Geometry .....	134
Table 58: Worldwide Design Start Forecast for SoPC SoC by Process Geometry .....	135
Table 59: Actionable Items for IP Subsystems, 1.....	139
Table 60: Actionable Items for IP Subsystems, 2.....	140
Table 61: Actionable Items for IP Subsystems, 3.....	141
Table 62: Actionable Items for IP Subsystems, 4.....	142

## List of Figures

---

Figure 1: SoC Unit Volumes Needed to Reach Breakeven Point.....	6
Figure 2: Functional Integration Drives New Markets .....	8
Figure 3: Discrete Semiconductor Market by Function and Type.....	10
Figure 4: Current Semiconductor IP Market Landscape .....	11
Figure 5: Evolved Semiconductor IP Market Landscape .....	13
Figure 6: Growth in the Number of SIP Blocks per Design .....	15
Figure 7: Average Gate Complexity Level by Device Type.....	16
Figure 8: Cost of SIP Integration With and Without SIP Subsystems.....	17
Figure 9: Crossover Point for IP Integration Cost: Silicon vs. Software .....	20
Figure 10: Discrete SIP Market Revenue Growth Over Time .....	22
Figure 11: First Deployment of an IP Subsystem – the TI OMAP2420 Processor.....	23
Figure 12: Fourth Generation of an IP Subsystem – the TI OMAP44x Processor .....	24
Figure 13. Revised Complexity Definitions for SoCs - I.....	27
Figure 14: Revised Complexity Definitions for SoCs - II .....	28
Figure 15: Contemporary Audio Block with Many ‘Moving Parts’ .....	32
Figure 16: Contemporary Audio Block from the System Level Perspective.....	33
Figure 17: First Memory IP Subsystem Introduced by Sonics, Inc. ....	34
Figure 18: First Power Management IP Subsystem Introduced by Sonics, Inc .....	35
Figure 19: First Audio IP Subsystem Introduced by Synopsys .....	36
Figure 20: First Storage IP Subsystem Introduced by Cadence Design Systems .....	37
Figure 21: First Imaging / Video Processing IP Subsystem Introduced by Cadence Design Systems .....	38
Figure 22: First Sensor IP Subsystem Introduced by Synopsys .....	39
Figure 23: First ARM IoT IP Subsystem.....	40
Figure 24: First Open Silicon High Bandwidth Memory IP Subsystem.....	41
Figure 25: Imaging and Vision IP Subsystem Platform Introduced by Ceva .....	42
Figure 26: Imaging and Vision IP Subsystem Architecture Introduced by Ceva .....	42
Figure 27: Wireless Connectivity IP Subsystem Platform Introduced by Andes Technology .....	43
Figure 28: Flash-Based Controller IP Subsystem Introduced by Andes Technology.....	44
Figure 29: IoT IP Subsystem Introduced by Andes Technology.....	45
Figure 30: Embedded Vision IP Subsystem Introduced by Imagination Technologies.....	46
Figure 31: Computing IP Subsystem Introduced by Imagination Technologies .....	47
Figure 32: NVMe IP Subsystem Introduced by Mobiveil .....	49
Figure 33: Secure Clocking, SerDes and Sensor IP Subsystems Introduced by Analog Bits.....	50
Figure 34: UltraSoC Embedded Debug IP Subsystem (Distributed).....	51
Figure 35: UltraSoC Embedded Debug IP Subsystem .....	52
Figure 36: Arteris Ncore Cache Coherent Memory IP Subsystem .....	53
Figure 37: Configurable ColdFire V1 IP Subsystem Platform Introduced by IP Extreme .....	54
Figure 38: Video Over Internet Protocol HD Encoder IP Subsystem Introduced by CAST .....	54
Figure 39: Synopsys Hardware / Software Integration Design Flow .....	56
Figure 40: Cadence Chip Design Flow Example.....	57
Figure 41: Cadence SoC Integration and Flow Part 1 .....	58
Figure 42: Cadence SoC Integration and Verification Flow Part 2 .....	58
Figure 43: Cadence SoC Integration and Verification Flow Part 3 .....	59
Figure 44: ‘Stylized’ IP Subsystem Concept from the System Level Perspective .....	60
Figure 45: Total Worldwide IP Subsystem Market Forecast; IDMs and IP Vendors.....	78
Figure 46: Worldwide IP Subsystem Revenue Forecast by IP Category.....	80
Figure 47: Worldwide Memory IP Subsystem Revenue Forecast by Application .....	81
Figure 48: Total Worldwide Video IP Subsystem Revenue Forecast by Application .....	82
Figure 49: Total Worldwide Communication IP Subsystem Revenue Forecast by Application .....	83
Figure 50: Total Worldwide Storage IP Subsystem Revenue Forecast by Application .....	84
Figure 51: Total Worldwide Multi Media IP Subsystem Revenue Forecast by Application.....	85

Figure 52: Total Worldwide Audio IP Subsystem Revenue Forecast by Application .....	86
Figure 53: Total Worldwide System Resource Mgmt. IP Subsystem Revenue Forecast by Application .....	87
Figure 54: Total Worldwide Security IP Subsystem Revenue Forecast by Application .....	88
Figure 55: Total Worldwide IoT Platform IP Subsystem Revenue Forecast by Application .....	89
Figure 56: Total Worldwide Computing IP Subsystem Revenue Forecast by Application .....	90
Figure 57: Total Worldwide Embedded Debug IP Subsystem Revenue Forecast by Application.....	91
Figure 58: Total Worldwide Embedded Vision IP Subsystem Revenue Forecast by Application.....	92
Figure 59: Total Worldwide Power Management IP Subsystem Revenue Forecast by Application .....	93
Figure 60: Worldwide IP Subsystem Market Revenue Forecast by Application Percent of Total.....	94
Figure 61: Worldwide IP Subsystem Market Forecast Revenues by Application.....	95
Figure 62: Worldwide IP Subsystem Unit Shipments Forecast by Application.....	96
Figure 63: Total Worldwide IP Subsystem Revenue Forecast for Consumer Applications .....	97
Figure 64: Worldwide IP Subsystem Unit Shipment Forecast for Consumer Applications by Device Type .....	98
Figure 65: Worldwide IP Subsystem Revenue Forecast for Computer Applications.....	99
Figure 66: Worldwide IP Subsystem Unit Shipment Forecast for Computer Applications by Device Type .....	100
Figure 67: Worldwide IP Subsystem Revenue Forecast for Communication Applications .....	101
Figure 68: Worldwide IP Subsystem Unit Shipment Forecast for Communication Applications by Device Type ....	102
Figure 69: Worldwide IP Subsystem Revenue Forecast for Automotive Applications .....	103
Figure 70: Worldwide IP Subsystem Unit Shipment Forecast for Automotive Applications by Device Type .....	104
Figure 71: Worldwide IP Subsystem Revenue Forecast for Industrial Applications .....	105
Figure 72: Worldwide IP Subsystem Unit Shipment Forecast for Industrial Applications by Device Type .....	106
Figure 73: Worldwide IP Subsystem Revenue Forecast for Military Applications .....	107
Figure 74: Worldwide IP Subsystem Unit Shipment Forecast for Military Applications by Device Type.	108
Figure 75: Worldwide IP Subsystem Revenue Forecast by Region .....	109
Figure 76: Americas IP Subsystem Revenue Forecast by Product Type.....	112
Figure 77: Europe IP Subsystem Revenue Forecast by Product Type .....	113
Figure 78: Japan IP Subsystem Revenue Forecast by Product Type.....	114
Figure 79: Asia Pacific IP Subsystem Revenue Forecast by Product Type.....	115
Figure 80: China IP Subsystem Revenue Forecast by Product Type .....	116
Figure 81: Original SoC Design Starts with Derivative Designs Removed .....	118
Figure 82: Worldwide IP Subsystem Design Start Forecast by Device Type .....	119
Figure 83: Worldwide Design Start Forecast for Advanced Performance Multicore SoC by Application .	120
Figure 84: Worldwide Design Start Forecast for Value Multicore SoC by Application .....	121
Figure 85: Worldwide Design Start Forecast for Basic SoC by Application .....	122
Figure 86: Worldwide Design Start Forecast for Programmable SoC by Application.....	123
Figure 87: Worldwide Design Start Forecast for Platform SoC by Application .....	124
Figure 88: Worldwide Design Start Forecast for Slice SoC by Application .....	125
Figure 89: Worldwide Design Start Forecast for SoPC SoC by Application .....	126
Figure 90: Total Worldwide Design Start Forecast for SoC by Process Geometry.....	128
Figure 91: Worldwide Design Start Forecast for Advanced Performance Multicore SoC by Process Geometry.....	129
Figure 92: Worldwide Design Start Forecast for Value Multicore SoC by Process Geometry .....	130
Figure 93: Worldwide Design Start Forecast for Basic SoC by Process Geometry .....	131
Figure 94: Worldwide Design Start Forecast for Programmable SoC by Process Geometry.....	132
Figure 95: Worldwide Design Start Forecast for Platform SoC by Process Geometry .....	133
Figure 96: Worldwide Design Start Forecast for Slice SoC by Process Geometry .....	134
Figure 97: Worldwide Design Start Forecast for SoPC SoC by Process Geometry.....	135